IPC ASSOCIATION ELECTRONIC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under bound international and Pan-American copyright conventions.				nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Form Type Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				rials and M	ials and Mfg Information			
Supplier	· Information													
Company name*			Company unique ID			1	Unique ID Authority				Response Date*			
onsemi										2024-04	2024-04-30			
Contact N	ame	Title - Contact]	Phone - Contact*				Email -	Email - Contact*			
Product-E	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorize	d Representative*	Title - Representative]	Phone - Representative*				Email - Representative*				
Product-E	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		Number Mfr Item Name			Effective Da	ite Vers	ion	Manufacturing Site		Weight*	UOM	Unit Type	
		NVATS5A107PLZT4 PCH 4.5V DR		PCH 4.5V DRIVE	VE SERIES		2024-04-30			CNG		267.68	mg	Each
Aanufa	cturing Proccess Informa	ntion												
	Terminal Plating / Grid Array M	Ferminal Base Alloy J-STD-020 MS		SL Rating	Peak Process Body Temperature		re Max Time at Peal	k Tempera	ture Nur	nber of Reflow Cyc	les			
contains Bi		CU Alloy 1			260 C		C	30	secor	nds 3				
Comments														
vel 1 - m	aximum time at peak temperat	ure during sol	ldering is 10-3	0 seconds										
or more i	information regarding material	composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, itssuppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-En									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.07	mg	Supplier	Silicon (Si)	7440-21-3		5.07	mg
Die Attach	5.43		Supplier	Silver (Ag)	7440-22-4		0.1075	mg
			A	Lead (Pb)	7439-92-1	7a	5.051	mg
			Supplier	Tin (Sn)	7440-31-5		0.2715	mg
Lead Frame	151.25		Supplier	Tin (Sn)	7440-31-5		0.2269	mg
			Supplier	Copper (Cu)	7440-50-8		151.0231	mg
Mold Compound-Black	102.62			Phenolic Resin	proprietary data		2.5655	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		8.4662	mg
			Supplier	Carbon Black (C)	1333-86-4		0.5131	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		90.5621	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.5131	mg
Plating	3.31	mg	В	Bismuth (Bi)	7440-69-9		0.0199	mg
			Supplier	Tin (Sn)	7440-31-5		3.2901	mg